International TOR Rectifier

Automotive Grade AUIRS211(0,3)S

HIGH- AND LOW-SIDE DRIVER

Features

- Floating channel designed for bootstrap operation
- Fully operational to +500 V or +600 V
- Tolerant to negative transient voltage dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V input logic compatible
- Separate logic supply range from 3.3 V to 20 V
- Logic and power ground ±5 V offset
- CMOS Schmitt-triggered inputs with pull-down
- Cycle by cycle edge-triggered shutdown logic
- Matched propagation delay for both channels
- Output in phase with inputs
- · Leadfree, roHS Compliant
- Automotive qualified*

Typical Applications

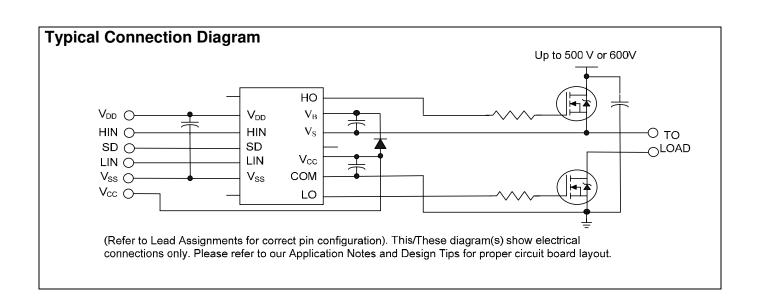
- · Hybrid electric vehicles
- Air condition drives, pumps, fans
- Automotive general purpose dual LS/HS driver
- Automotive motor drives
- Automotive DC/DC converters
- Automotive injection control

Product Summary

Topology		2 channels		
	AUIRS2110	500 V max		
V _{OFFSET}	AUIRS2113	600 V max		
V _{OUT}		10 V – 20 V		
I _{o+} & I _{o-} (typical)		2.5 A / 2.5 A		
t _{ON} & t _{OFF} (typical)		140 ns & 120 ns		
Delay Matching (max.)		35 ns max		

Package Option





International TOR Rectifier

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International TOR Rectifier

Description

The AUIRS211(0,3)S are high voltage, high speed power MOSFET and IGBT drivers with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 500 V or 600 V.

Qualification Information[†]

<u>Qualification ii</u>						
		Automotive (per AEC-Q100 ^{††})				
Qualification Leve	el	Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification leving granted by extension of the higher Automotive level.				
Moisture Sensitiv	Moisture Sensitivity Level SOIC16W MSL3 ^{†††} 260°C (per IPC/JEDEC J-ST					
	Machine Model		Class M2 (Pass +/-200V) (per AEC-Q100-003)			
ESD	Human Body Model	Class H1B (Pass +/-1000V) (per AEC-Q100-002)				
	Charged Device Model	Class C4 (Pass +/-1000V) (per AEC-Q100-011)				
IC Latch-Up Test		Class II, Level A (per AEC-Q100-004)				
RoHS Compliant		Yes				

[†] Qualification standards can be found at International Rectifier's web site http://www.irf.com/

^{††} Exceptions to AEC-Q100 requirements are noted in the qualification report.

^{†††} Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V_{B}	High-side floating supply voltage	(AUIRS2110)	-0.3	520 (†)	
v _B	Thigh-side hoating supply voltage	(AUIRS2113)	-0.3	620 (†)	
Vs	High-side floating supply offset voltage		V _B - 20	$V_{B} + 0.3$	
V_{HO}	High-side floating output voltage		V _S - 0.3	$V_{B} + 0.3$	
V _{CC}	Low-side fixed supply voltage		-0.3	20	V
V_{LO}	Low-side output voltage	-0.3	V _{CC} + 0.3		
V_{DD}	Logic supply voltage	-0.3	V _{SS} + 20 (†)		
V_{SS}	Logic supply offset voltage	V _{CC} - 20	$V_{CC} + 0.3$		
V_{IN}	Logic input voltage (HIN, LIN & SD)	V _{SS} -0.3	$V_{DD} + 0.3$		
dV _S /dt	Allowable offset supply voltage transient (Fig.		50	V/ns	
P_{D}	Package power dissipation @ TA ≤ 25°C		_	1.25	W
Rth _{JA}	Thermal resistance, junction to ambient	_	100	°C/W	
TJ	Junction temperature	_	150		
Ts	Storage temperature	-55	150	°C	
T _L	Lead temperature (soldering, 10 seconds)		_	300	

[†] All supplies are fully tested at 25 V, and an internal 20 V clamp exists for each supply.

Recommended Operating Conditions

The input/output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset rating are tested with all supplies biased at 15 V differential.

Symbol	Definition	Min.	Max.	Units	
V_B	High-side floating supply absolute voltage	V _S +10	V _S +20		
Vs	High-side floating supply offset voltage	(AUIRS2110)	†	500	
VS	riigh-side hoating supply onset voltage	(AUIRS2113)	†	600	
V_{HO}	High-side floating output voltage	V_S	V_{B}		
V_{CC}	Low-side fixed supply voltage	10	20	V	
V_{LO}	Low-side output voltage	0	V_{CC}		
V_{DD}	Logic supply voltage	$V_{SS} + 3$	V _{SS} + 20		
V_{SS}	Logic ground offset voltage	-5 (††)	5		
V_{IN}	Logic input voltage (HIN, LIN & SD)	V_{SS}	V_{DD}		
T_A	Ambient temperature			125	°C

[†] Logic operational for V_S of -4 V to +500 V. Logic state held for V_S of -4 V to – V_{BS} . (Please refer to the Design Tip DT97 -3 for more details).

^{††} When V_{DD} < 5 V, the minimum V_{SS} offset is limited to $-V_{DD}$.



Static Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C \leq Tj \leq 125°C with bias conditions of V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15 V, V_{SS} = COM. The V_{IL} , V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_{O} , and I_{O} parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min	Тур	Max	Units	Test Conditions
V_{IH}	Logic "1" input voltage	9.5	_	_		
V_{IL}	Logic "0" input voltage	_		6.0	V	
V_{OH}	High level output voltage, V_{BIAS} - V_{O}	_		1.4	v	$I_O = 0 A$
V_{OL}	Low level output voltage, V _O	_		0.15		$I_O = 20 \text{ mA}$
I _{LK}	Offset supply leakage current	_	_	50		$V_B = V_S = 500$ V/600 V
I_{QBS}	Quiescent V _{BS} supply current		70	130		
I _{QCC}	Quiescent V _{CC} supply current		125	230	μΑ	$V_{IN} = 0 \text{ V or } V_{DD}$
I_{QDD}	Quiescent V _{DD} supply current		5	30		
I _{IN+}	Logic "1" input bias current	_	20	40		$V_{IN} = V_{DD}$
I _{IN-}	Logic "0" input bias current	_	_	5.0		$V_{IN} = 0 V$
V_{BSUV+}	V _{BS} supply undervoltage positive going threshold	7.5	8.6	9.7		
V_{BSUV}	V _{BS} supply undervoltage negative going threshold	7.0	8.2	9.4	V	
V_{CCUV+}	V _{CC} supply undervoltage positive going threshold	7.4	8.5	9.6	v	
V_{CCUV}	V _{CC} supply undervoltage negative going threshold	7.0	8.2	9.4		
I _{O+}	Output high short circuit pulsed current (†)	2.0	2.5		Α	$V_O = 0 V$, $V_{IN} = V_{DD}$ $PW \le 10 \text{ us}$
I _{O-}	Output low short circuit pulsed current ^(†)	2.0	2.5	_	Α	$V_O = 15 V$, $V_{IN} = 0 V$ $PW \le 10 us$

^(†) Guaranteed by design

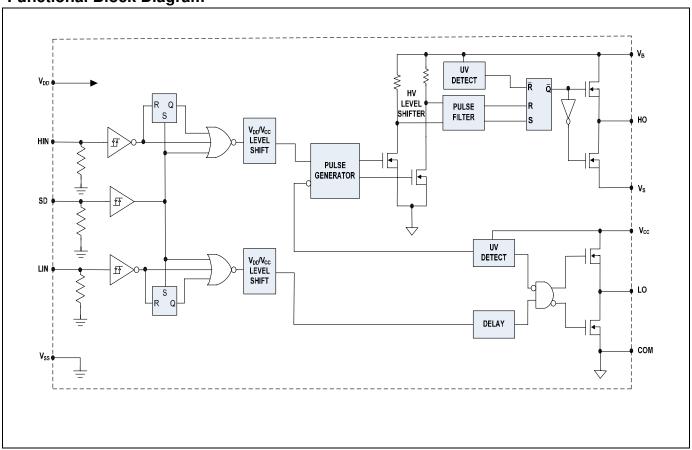
Dynamic Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of -40°C \leq Tj \leq 125°C with bias conditions of V_{BIAS} (V_{CC}, V_{BS}, V_{DD}) = 15 V, C_L = 1000 pF, and V_{SS} = COM. The dynamic electrical characteristics are measured using the test circuit shown in Fig. 3.

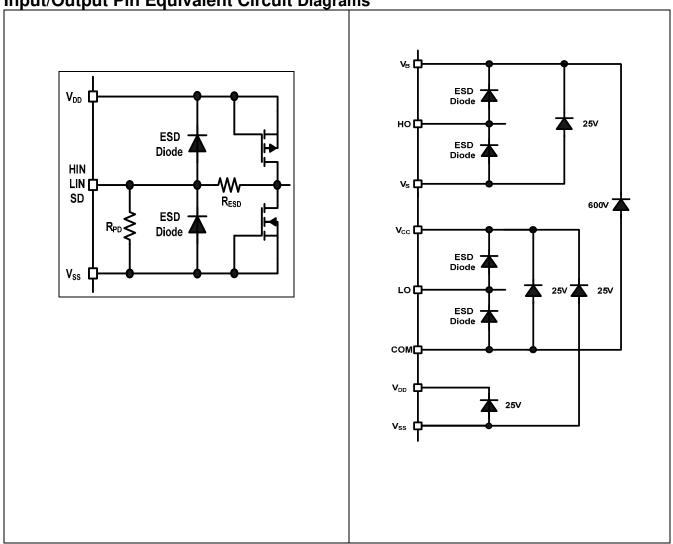
Symbol	Definition	Min	Тур	Max	Units	Test Conditions
t _{on}	Turn-on propagation delay	_	140	230		$V_S = 0 V$
t_{off}	Turn-off propagation delay	_	120	210	0	
t_{sd}	Shutdown propagation delay	_	125	220	no	V _S = 500 V/600 V
tr	Turn-on rise time	_	25	40	ns	
t _f	Turn-off fall time	_	15	30		
MT	Delay matching, HS & LS turn on/off	_		35		

Note: Please refer to figures in Parameter Temperature Trends section

Functional Block Diagram



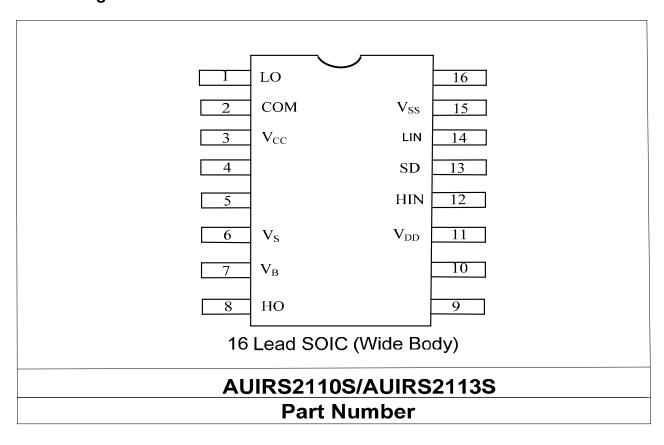
Input/Output Pin Equivalent Circuit Diagrams



Lead Definitions

Pin	Symbol	Description	
1	LO	Low-side gate drive output	
2	COM	Low-side return	
3	V _{CC}	Low-side supply	
4	NC	Not connected	
5	NC	Not connected	
6	Vs	High-side floating supply return	
7	V _B	High-side floating supply	
8	НО	High-side gate drive output	
9	NC	Not connected	
10	NC	Not connected	
11	V_{DD}	Logic supply	
12	HIN	Logic input for high-side gate driver output (HO), in phase	
13	SD	Logic input for shutdown	
14	LIN	Logic input for low-side gate driver output (LO), in phase	
15	V_{SS}	Logic ground	
16	NC	Not connected	

Lead Assignments



Application Information and Additional Details

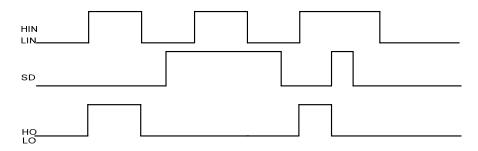


Figure 1: Input/Output Timing Diagram

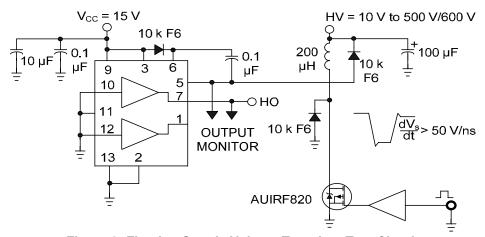


Figure 2: Floating Supply Voltage Transient Test Circuit

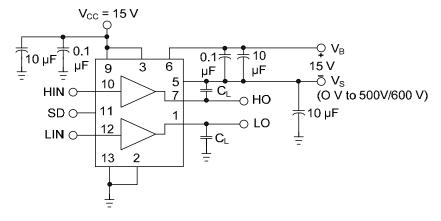


Figure 3: Switching Time Test Circuit

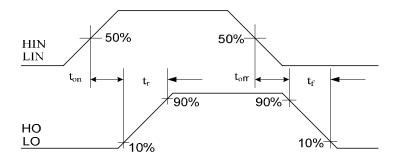


Figure 4: Switching Time Waveform Definitions

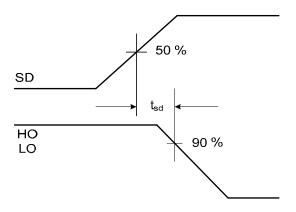


Figure 5: Shutdown Waveform Definitions

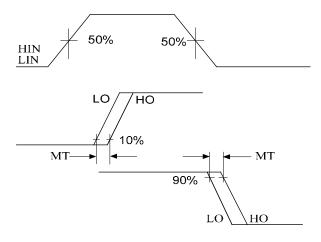


Figure 6: Delay Matching Waveform Definitions

Parameter Temperature Trends

Figures illustrated in this chapter provide information on the experimental performance of the AUIRS211(0,3)S HVIC. The line plotted in each figure is generated from actual lab data. A large number of individual samples were tested at three temperatures (-40 °C, 25 °C, and 125 °C) in order to generate the experimental curve. The line consists of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the Typ. curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).

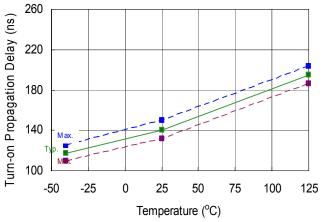


Figure 7. Turn-On Time vs. Temperature

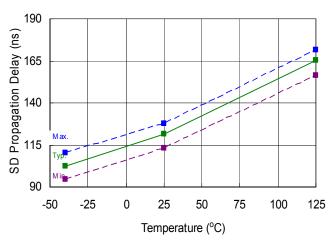


Figure 9. Shutdown Time vs. Temperature

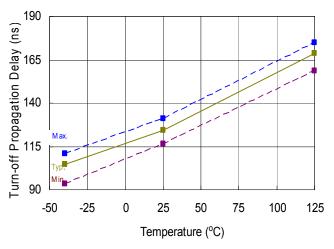


Figure 8. Turn-Off Time vs. Temperature

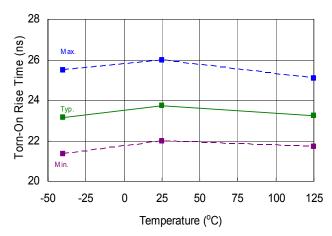


Figure 10. Turn-On Rise Time vs. Temperature

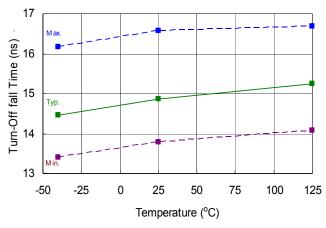


Figure 11. Turn-Off Fall Time vs. Temperature

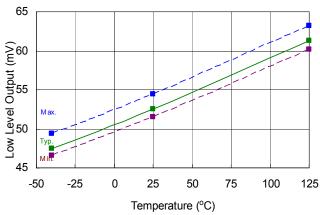


Figure 13. Low Level Output vs. Temperature

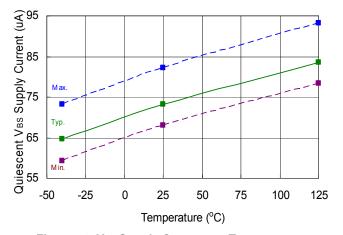


Figure 15. V_{BS} Supply Current vs. Temperature

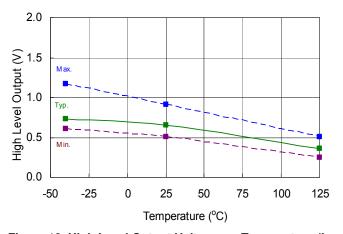


Figure 12. High Level Output Voltage vs. Temperature (I_0 = 0 mA)

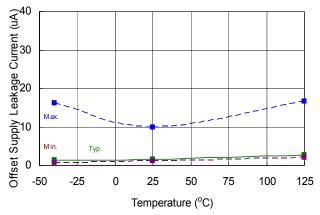


Figure 14. Offset Supply Current vs. Temperature

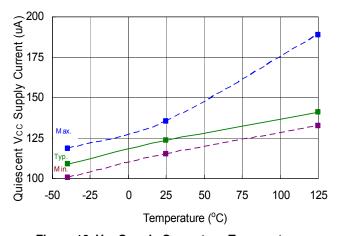


Figure 16. V_{CC} Supply Current vs. Temperature

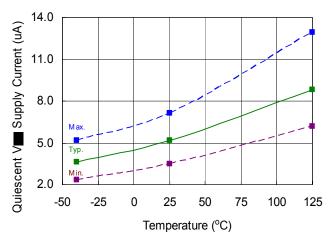


Figure 17. V_{DD} Supply Current vs. Temperature

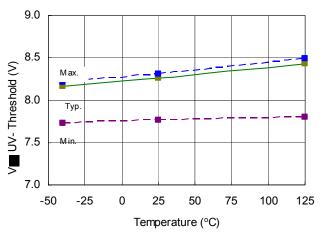


Figure 19. V_{BS} Undervoltage (-) vs. Temperature

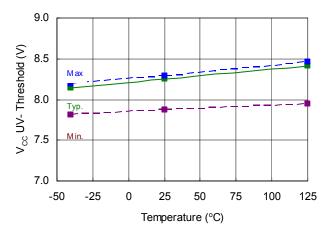


Figure 21. V_{CC} Undervoltage (-) vs. Temperature

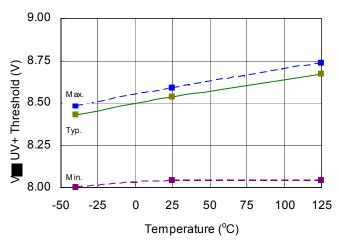


Figure 18. V_{BS} Undervoltage (+) vs. Temperature

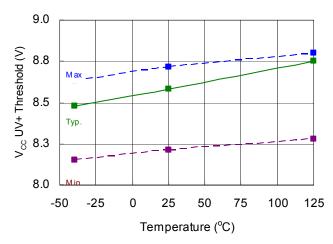
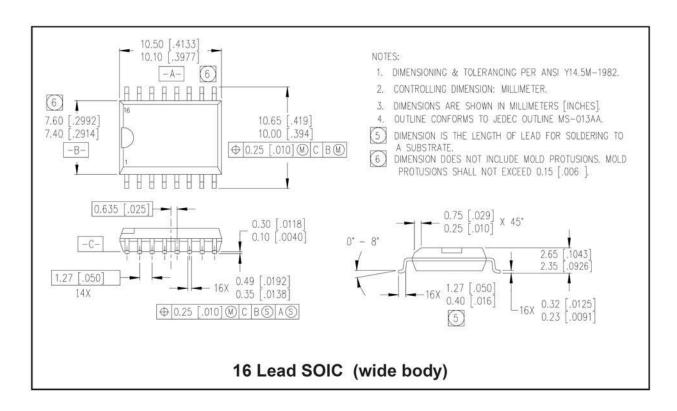
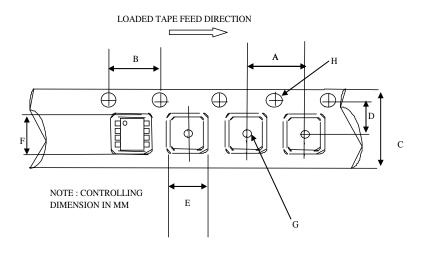


Figure 20. V_{CC} Undervoltage (+) vs. Temperature

Package Details: SOIC16WB

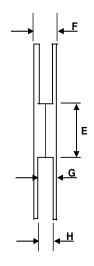


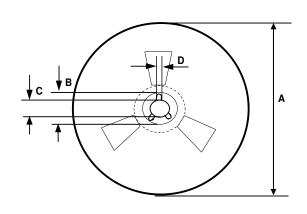
Tape and Reel Details: SOIC16WB



CARRIER TAPE DIMENSION FOR 16SOICN

	Metric		Imperial		
Code	Min	Max	Min	Max	
Α	7.90	8.10	0.311	0.318	
В	3.90	4.10	0.153	0.161	
С	15.70	16.30	0.618	0.641	
D	7.40	7.60	0.291	0.299	
E	6.40	6.60	0.252	0.260	
F	10.20	10.40	0.402	0.409	
G	1.50	n/a	0.059	n/a	
Н	1.50	1.60	0.059	0.062	

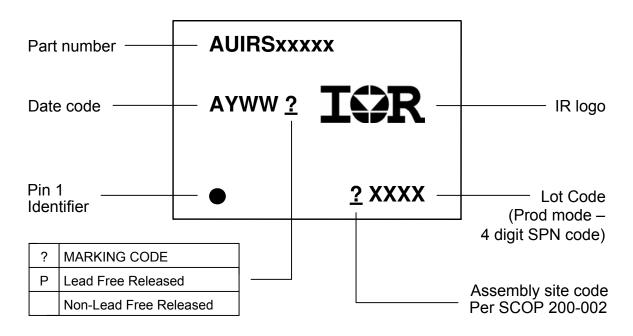




REEL DIMENSIONS FOR 16SOICN

	Metric		Imperial		
Code	Min	Max	Min	Max	
Α	329.60	330.25	12.976	13.001	
В	20.95	21.45	0.824	0.844	
С	12.80	13.20	0.503	0.519	
D	1.95	2.45	0.767	0.096	
Е	98.00	102.00	3.858	4.015	
F	n/a	22.40	n/a	0.881	
G	18.50	21.10	0.728	0.830	
Н	16.40	18.40	0.645	0.724	

Part Marking Information



Ordering Information

		Standard Pa	ck	Orangel de Bred Newsham	
Base Part Number	Package Type	Form	Quantity	Complete Part Number	
ALUD004400	SOIC16W	Tube/Bulk	25	AUIRS2110S	
AUIRS2110S	30101000	Tape and Reel	1000	AUIRS2110STR	
AL IID004400	SOIC16W	Tube/Bulk	25	AUIRS2113S	
AUIRS2113S	30101000	Tape and Reel	1000	AUIRS2113STR	



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